



**THE DATASHEET OF
ESD8V0R1B02ELSE6327XTSA1**



TVS Diodes

Transient Voltage Suppressor Diodes

ESD8V0R1B Series

Bi-directional Low Capacitance TVS Diode

ESD8V0R1B-02EL
ESD8V0R1B-02ELS

Data Sheet

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Revision History

| Page or Item | Subjects (major changes since previous revision) |
|---------------------------------|--|
| Revision 1.0, 2010-10-20 | |
| | |
| Revision 2.0, 2010-12-15 | |
| | Carrier Tape drawing for TSSLP-2-2 Package updated |
| | |
| | |

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Last Trademarks Update 2010-06-09

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1 Bi-directional Low Capacitance TVS Diode

1.1 Features

- ESD / Transient protection of data lines in 3.3 / 5 / 12 V applications according to :
 - IEC61000-4-2 (ESD) : ± 20 kV (air) and ± 18 kV (contact)
 - IEC61000-4-4 (EFT) : 40 A (5/50ns)
- Extremely small form factor down to 0.62 x 0.32 x 0.31 mm²
- Maximum working voltage: $V_{RWM} = -8 / +14$ V
- Very low reverse current: $I_R < 1$ nA (typical)
- Very low series inductance down to : $L_S = 0.2$ nH (typical)
- Low capacitance $C_L = 4$ pF I/O to GND (typical)
- Pb-free and Halogen-Free package (RoHS compliant)

1.2 Application Examples

- Keypad, touchpad, buttons, convenience keys
- LCD displays, Camera, audio lines, mobile communication, Consumer products (E-Book, MP3, DVD, DSC, ...)
- Notebooks tablets and desktop computers and their peripherals



2 Product Description

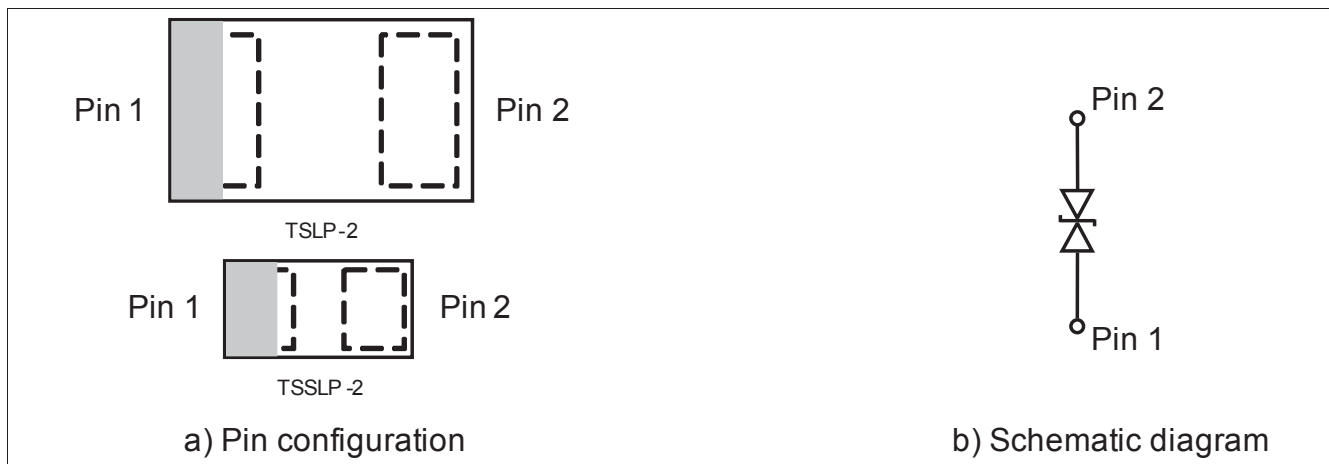


Figure 1 a) Pin Configuration and b) Schematic Diagram

Table 1 Ordering information

| Type | Package | Configuration | Marking code |
|-----------------|--------------|------------------------|--------------|
| ESD8V0R1B-02EL | PG-TSLP-2-18 | 1 line, bi-directional | R |
| ESD8V0R1B-02ELS | PG-TSSLP-2-2 | 1 line, bi-directional | D |

3 Characteristics

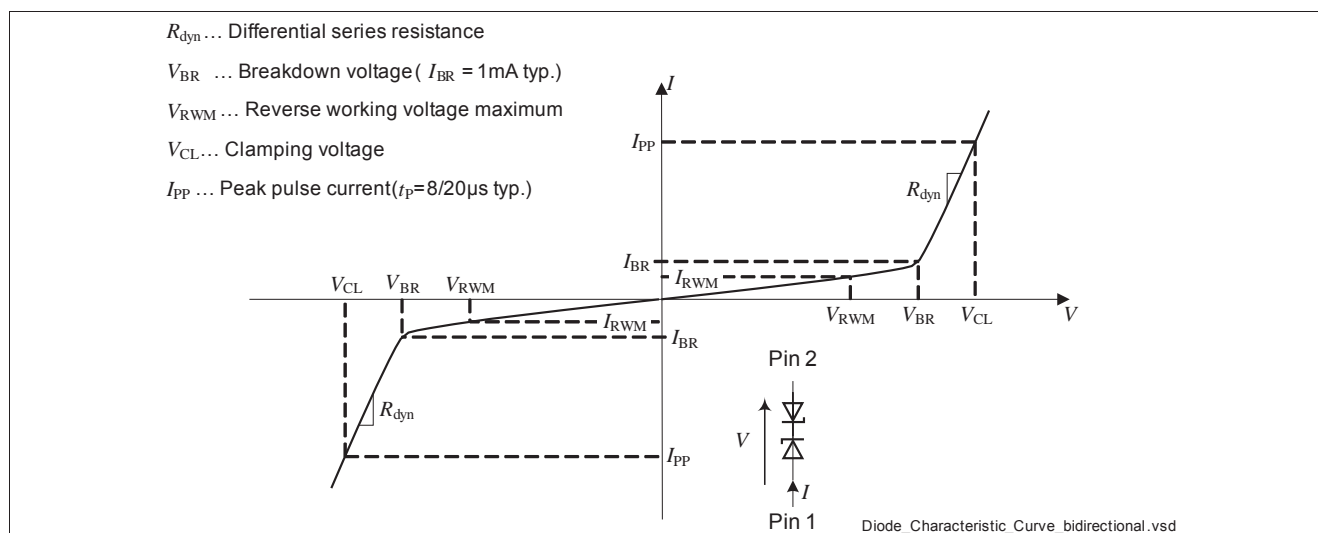
Table 2 Maximum Rating at $T_A = 25\text{ }^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Values | | | Unit |
|--|-----------|--------|------|------|------------------|
| | | Min. | Typ. | Max. | |
| ESD air discharge ¹⁾ | V_{ESD} | -20 | – | 20 | kV |
| ESD contact discharge ¹⁾ | V_{ESD} | -18 | – | 18 | kV |
| Peak pulse current ($t_p = 8/20\ \mu\text{s}$) ²⁾ | I_{PP} | -1 | – | 1 | A |
| Operating temperature | T_{OP} | -55 | – | 150 | $^\circ\text{C}$ |
| Storage temperature | T_{stg} | -65 | – | 150 | $^\circ\text{C}$ |

 1) V_{ESD} according to IEC61000-4-2

 2) I_{PP} according to IEC61000-4-5

3.1 Electrical Characteristics at $T_A = 25\text{ }^\circ\text{C}$, unless otherwise specified


Figure 2 Definitions of electrical characteristics
Table 3 DC characteristics at $T_A = 25\text{ }^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Values | | | Unit | Note / Test Condition |
|-------------------------|-----------|--------|------|------|------|--|
| | | Min. | Typ. | Max. | | |
| Reverse working voltage | V_{RWM} | -8 | – | 14 | V | from Pin2 to Pin1 |
| Breakdown voltage | V_{BR} | 8.5 | 11 | 14 | V | $I_R = 1\text{ mA}$, from Pin1 to Pin2 |
| Breakdown voltage | V_{BR} | 14.5 | 17 | 20 | V | $I_R = 1\text{ mA}$, from Pin2 to Pin1 |
| Reverse current | I_R | – | <1 | 50 | nA | $V_R = 3.3\text{ V}$ |

Table 4 RF characteristics at $T_A = 25\text{ °C}$, unless otherwise specified

| Parameter | Symbol | Values | | | Unit | Note / Test Condition |
|------------------|--------|--------|------|------|------|--|
| | | Min. | Typ. | Max. | | |
| Line capacitance | C_L | – | 4 | 7 | pF | $V_R = 0\text{ V}$, $f = 1\text{ MHz}$, I/O to <i>GND</i> |
| Serie inductance | L_S | – | 0.4 | – | nH | ESD8V0R1B-02EL |
| | L_S | – | 0.2 | – | nH | ESD8V0R1B-02ELS |

Table 5 ESD characteristics at $T_A = 25\text{ °C}$, unless otherwise specified

| Parameter | Symbol | Values | | | Unit | Note / Test Condition |
|--------------------------------|----------|--------|------|------|------|--|
| | | Min. | Typ. | Max. | | |
| Clamping voltage ¹⁾ | V_{CL} | – | 17 | 22 | V | $I_{PP} = 1\text{ A}$ from Pin1 to Pin2 |
| | V_{CL} | – | 23 | 28 | V | $I_{PP} = 1\text{ A}$ from Pin2 to Pin1 |

1) According to IEC61000-4-5 ($t_p : 8 / 20\text{ }\mu\text{s}$)

3.2 Typical Performance characteristics at $T_A = 25\text{ }^\circ\text{C}$, unless otherwise specified

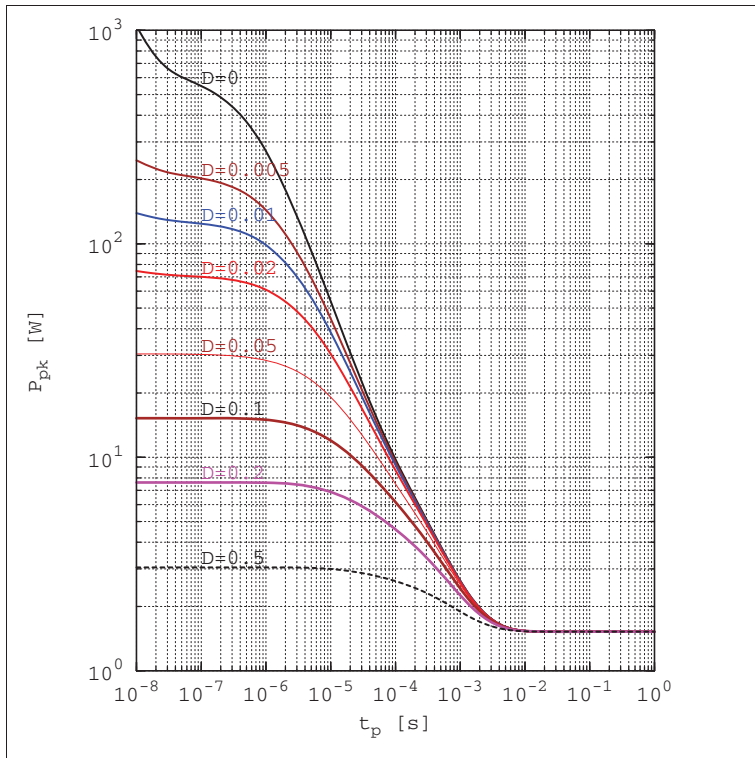


Figure 3 Non-repetitive peak pulse power: $P_{pk} = f(t_p)$

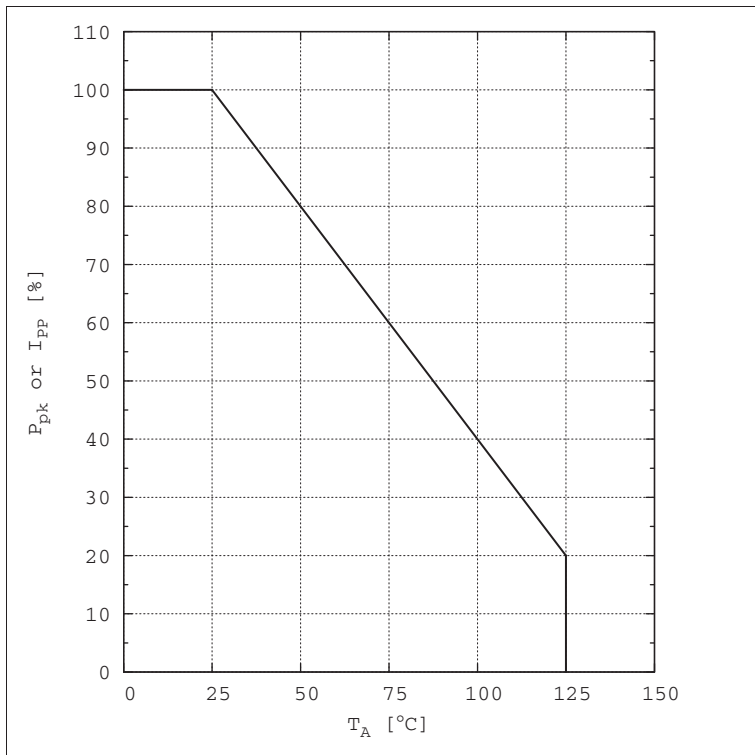


Figure 4 Power derating curve: $P_{pk} = f(T_A)$

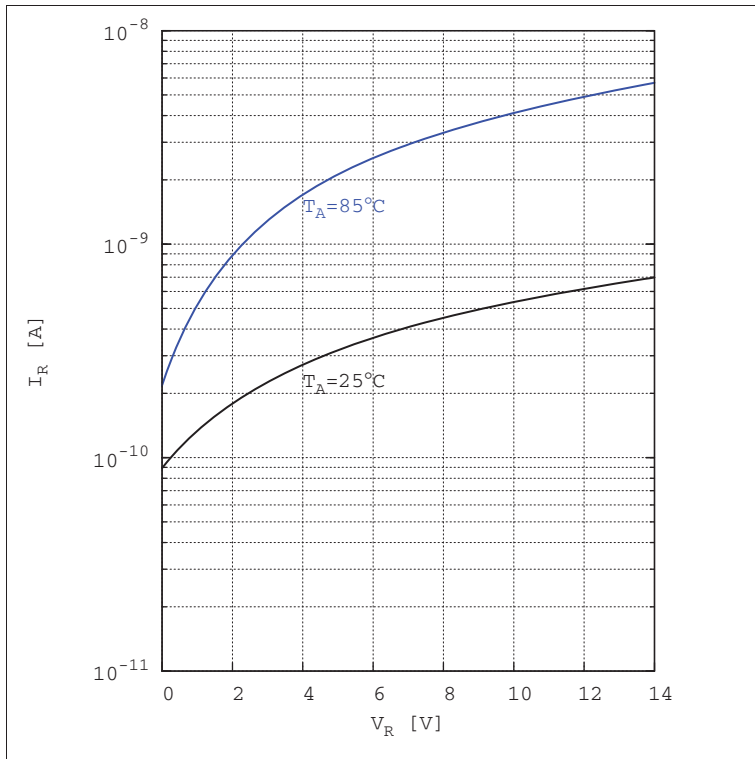


Figure 5 Reverse characteristic, $I_R = f(V_R)$, $T_A = \text{parameter}$

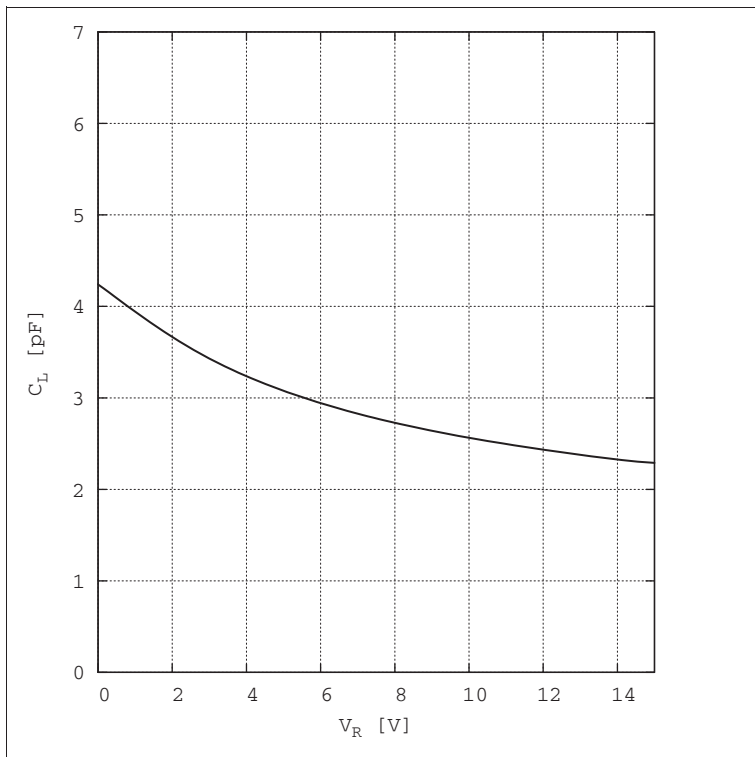


Figure 6 Line capacitance $C_L = f(V_R)$

4 Application Information

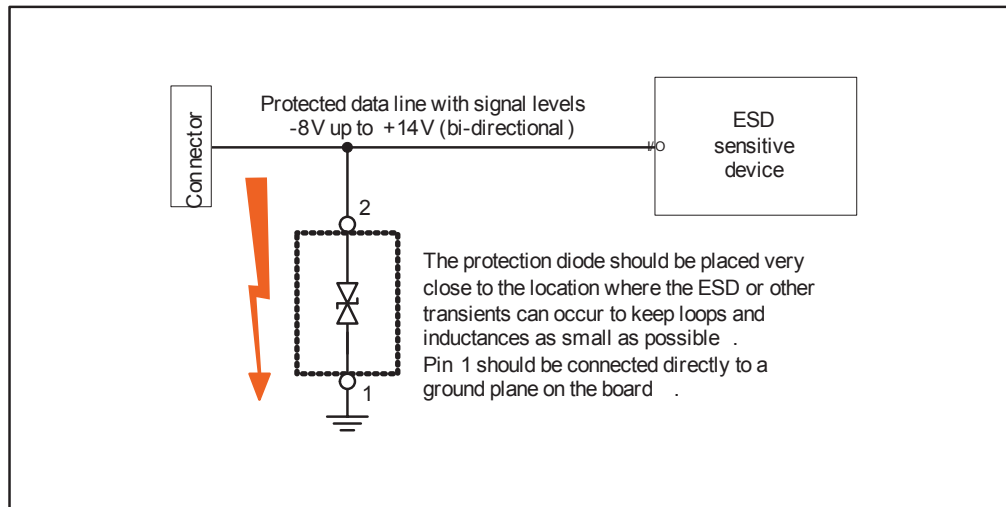


Figure 7 1 Line, bi-directional protection with ESD diode

5 Ordering information scheme

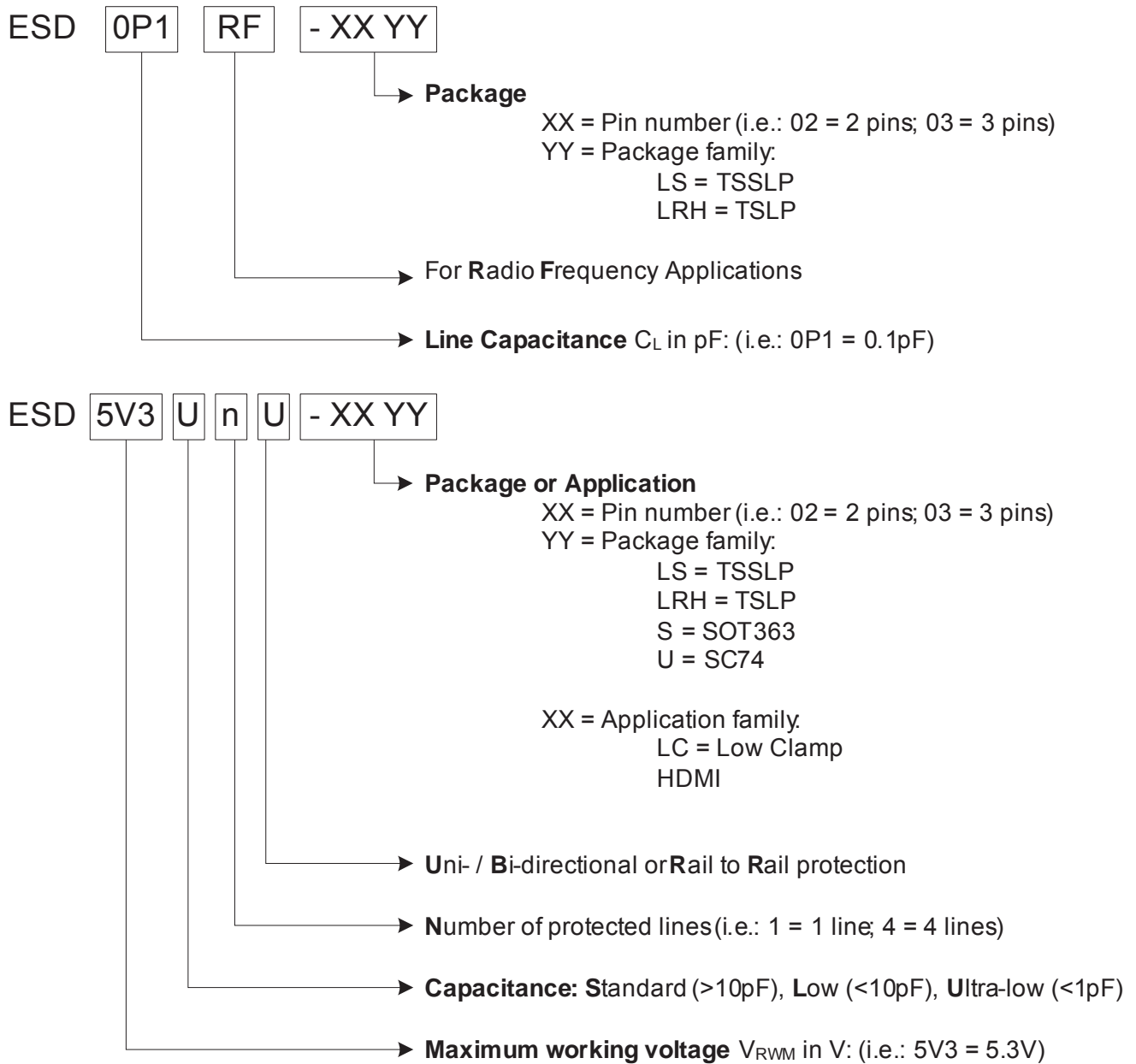
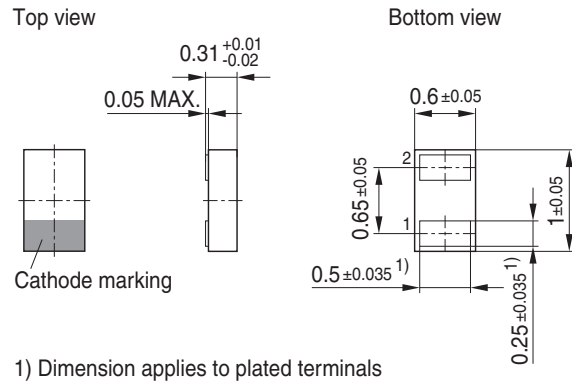


Figure 8 Ordering Information Scheme (examples)

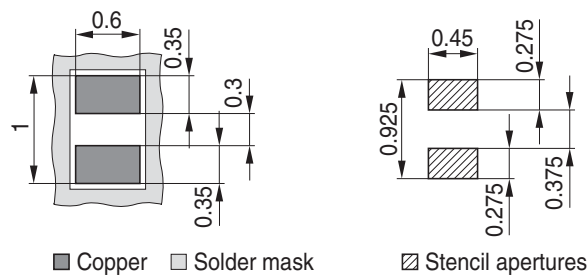
6 Package Information

6.1 PG-TSLP-2-18



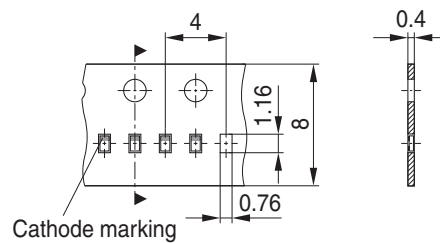
TSLP-2-18-PO V01

Figure 9 PG-TSLP-2-18: Package Overview



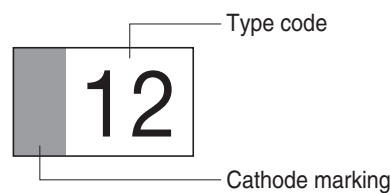
TSLP-2-18-FP V01

Figure 10 PG-TSLP-2-18: Footprint



TSLP-2-18-TP V01

Figure 11 PG-TSLP-2-18: Packing



TSLP-2-18-MK V01

Figure 12 PG-TSLP-2-18: Marking (example)

6.2 PG-TSSLP-2-2

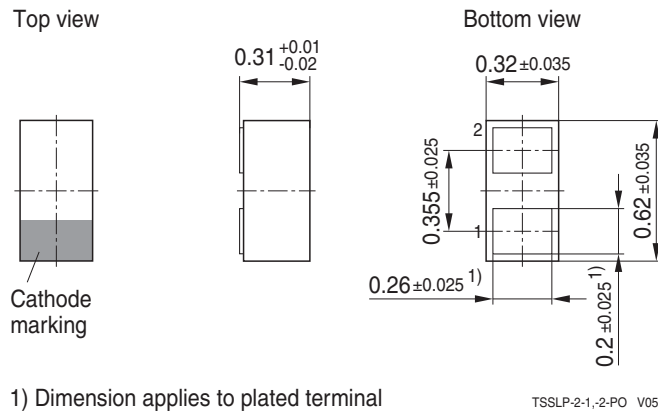


Figure 13 PG-TSSLP-2-2: Package Overview

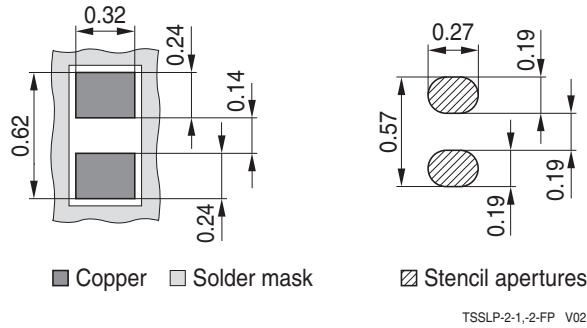
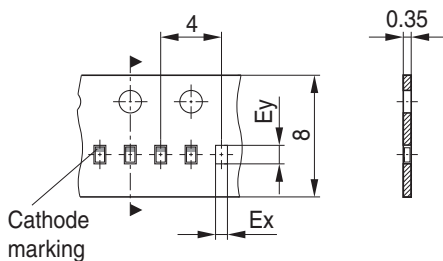


Figure 14 PG-TSSLP-2-2: Footprint



| Tape type | Ex | Ey |
|---------------|------|------|
| Punched Tape | 0.43 | 0.73 |
| Embossed Tape | 0.37 | 0.67 |

Deliveries can be both tape types (no selection possible).
Specification allows identical processing (pick & place) by users.

TSSLP-2-1,-2-TP V03

Figure 15 PG-TSSLP-2-2: Packing

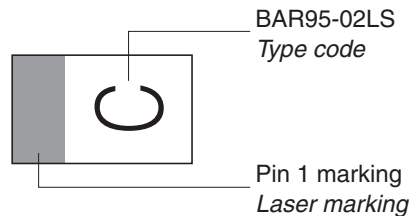


Figure 16 PG-TSSLP-2-2: Marking (example)

Terminology

| | |
|-------------|---|
| C_L | Line capacitance |
| DSC | Digital Still Camera |
| DVD | Digital Versatile Disc |
| EFT | Electrical Fast Transient |
| ESD | Electrostatic Discharge |
| IEC | International Electrotechnical Commission |
| I_{PP} | Peak pulse current |
| I_R | Reverse current |
| I_{RWM} | Reverse working current maximum |
| LCD | Liquid Crystal Display |
| L_S | Serial inductance |
| MP3 | Moving Picture Experts Group III |
| RoHS | Restriction of Hazardous Substances Directive |
| T_A | Ambient temperature |
| T_{OP} | Operation temperature |
| t_p | Pulse duration |
| T_{stg} | Storage temperature |
| V_{CL} | Reverse clamping voltage |
| V_{ESD} | Electrostatic discharge voltage |
| V_R | Reverse voltage |
| V_{RWM} | Reverse working voltage maximum |

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